

NOTICE TO BIDDERS

Notice is hereby given that sealed bids will be accepted for Technology Bid Package No. 9 - Valparaiso High School Security and Sound Systems Upgrades. Bids will be received at the Administration Office of the Valparaiso Community Schools, 3801 North Campbell Street, Valparaiso, Indiana 46385, until 3:30 p.m. local time (CDT), Friday June 14th, 2019. Bids received after that time will be returned unopened. Bids will be publicly opened and read aloud.

Bids shall be submitted on forms provided in the Project Manual and include a fully executed Indiana State Board of Accounts Form 96 (revised 2013) - "Contractor's Bid for Public Works", with a financial statement complying with Section III of Form 96, and a satisfactory Bid Bond or certified check pursuant to I.C. 36-1-9-36, payable to Valparaiso Community Schools. Bid Security shall be in the amount of not less than 10% of the total bid price. Should a successful Bidder withdraw their Bid or otherwise fail to execute a satisfactory Contract the Owner may then declare the Bid security forfeited as liquidated damages.

Each Bid shall be delivered in a sealed envelope plainly labeled to indicate the following:

Addressed to:

Valparaiso Community Schools
Attention: Sharon Qualkenbush
3801 North Campbell Street
Valparaiso, IN 46385

Marked: Technology Bid Pack No. 9

All bids shall be in full compliance with the bid documents which are on file with and distributed via download from Technology Dynamics, available upon registration at <https://forms.gle/h3Di4iZq5Crp3mHM8>

The Contractor receiving the award may be required to furnish an approved Performance and Payment Bond in the amount of 100% of the contract amount, which shall remain in full force and effect for twelve months after the date of acceptance of the Work.

The Owner expects to award the Contract for the Work to the most responsible and responsive Bidder on or before June 28th, 2019. The Owner reserves the right to reject any bid, and to waive irregularities in the Bidding.

A Pre-Bid Meeting is scheduled for May 29th, 2019 at 3:00 p.m. local time (CDT). Meet at Valparaiso High School located at 2727 N. Campbell St. Valparaiso, IN 46385. Attendance is recommended but not required to provide a bid. Questions pertaining to this Project shall be directed in writing to:

Brian Scott
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5/21, 5/28/19 - hspaxlp